ASSOCIATION CONNECTING LECTRONICS INDUSTRIES® COpyright 2005. IPC international and Pan-A	. Bannockb	urn. Illinois. A	ll rights reserved untions.	under both	This docume level parts, t	ent is a declaration	ion of the s encompasse	ubstances es all lowe	within the m r level mater	nanufacture rials for whi	r listed item ich the man	. Note: if ifacturer	the item is an as the engineering	sembly with lowe responsibility.
	-21.1 IPC Web Site for Information on IPC-1752 Standard Form 7 http://www.ipc.org/IPC-175x Distrib				e *	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia					als and Mfg Information			
Supplier Information														
Company name* Company			pany unique ID			Unique ID Authority					Response Date*			
onsemi											2025-06-06			
Contact Name	tact Name Title - Contact					Phone - Contact*					Email - Contact*			
Product-Env-Stewards Product Enviro			ro Compliance			NA					Product-Env-Stewards@onsemi.com			
Authorized Representative* Title - Representative			sentative			Phone - Representative*					Email - Representative*			
Product-Env-Stewards Product F			luct Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Item Number		Mfr Item Name			Effective Date	Version]	Manufacturing Site		We	ght*	UOM	Unit Type
	SZBZX8	ZBZX84C3V3LT3G ZEN SOT23 REG		.225W		2025-06-06			CN1		8.02	!	mg	Each
Manufacturing Proccess Informatio	on		·											·
Terminal Plating / Grid Array Mater	Material Terminal Base Alloy		Alloy	J-STD-020 MS	L Rating	Peak Pro	k Process Body Temperature Max Time at Peak		ne at Peak T	Temperature Number of Reflow Cycles		les		
Matte Tin (Sn) - annealed CU Alloy			1		260		С	30		seconds	3			
Comments														
evel 1 - maximum time at peak temperature	during sol	dering is 10-3	0 seconds											
for more information regarding material co	mposition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed			
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth				
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of			
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted				
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all			
Exemption List Version	EL-2011/534/EU							
Declaration Signature								
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.								
Supplier Digital Signature Ra	stislav Drska	Le						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3

sigma range of distribution unless	otherwise noted).							
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.05	mg	Supplier	Silicon (Si)	7440-21-3		0.05	mg
Lead Frame 2.9	2.92	mg	В	Nickel (Ni)	7440-02-0		1.06	mg
			Supplier	Iron (Fe)	7439-89-6		1.4658	mg
			Supplier	Copper (Cu)	7440-50-8		0.3942	mg
Mold Compound-Black	4.9	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.49	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0245	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		0.7105	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		3.185	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.49	mg
Plating	0.14	mg	Supplier	Tin (Sn)	7440-31-5		0.14	mg
Wire Bond - Cu	0.01	mg	Supplier	Copper (Cu)	7440-50-8		0.01	mg